



PC Board Layout Component Side Shown

REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
△		P/N MODIFY	shy 03/12/'00	
△		DRAWING MODIFY	shy 07/14/'00	H
△		P/N MODIFY	shy 11/28/'00	
△		P/N MODIFY	SHE 07/13/'04	
△		ADD PORT NOTE	LUXIN 01/14/'05	
△		P/N MODIFY	HAOQIN 4/01/'05	

NOTES:

ELECTRICAL:

- VOLTAGE RATING : 125 VAC RMS.
- CURRENT RATING : 1.5 AMP.
- CONTACT RESISTANCE : 30 MILLIOHMS MAX. △
- INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC. △
- DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

- HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
- CONTACT MATERIAL : PHOSPHOR BRONZE Ø0.46mm.
- PLATING : GOLD PLATING OVER NICKEL.
- OPERATING LIFE : 750 CYCLES MIN. △
- PCB RETENTION PRE-SOLDER : 1 LB MIN.
- PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

- STORAGE : -40°C TO +85°C.
- OPERATION: 0°C TO 70°C.

MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68, SUBPART F.

CUL FILE NO. E163191

PART NUMBER: E5544-60LXXX

- △ 0- BK
- △ 1- GY
- △ A-GLASSY
- △ U-BK FR52

- 1-W/ PANEL STOP
- 2-W/O PANEL STOP

- 1- 3u" 4-30u"
- 2- 6u" 5-50u"
- 3-15u" 6-Pd20u"

DETACHED LISTS	← MM (INCH) →		DFTO SYZ	DATE 03/04/99	FULL RISE ELECTRONIC CO., LTD	
	TOLERANCES EXCEPT AS NOTED		CHKD QIANPU	DATE 2005/4/1		
	MM	±	MFO	DATE	TITLE MINI L/P PCB JACK 4P	
	.0 ±0.20	±	APPV LUSHEN	DATE 2005/4/1		
.00 ±0.15	±	MATERIAL :		DRAWING NO. GE553018		
.000 ±0.075	±	ANGLES ±		/PART NO. SEE NOTE		
THIRD ANGLE PROJECTION		QT'Y :		SIZE A3	REV 6	
		FINISH :		DO NOT SCALE DRAWING		
		SCALE : 3:1		SHEET X OF Y		